



PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

JOHN ALBERT TOEBES, et al.

Application No.: 10/061,553

Filed: February 1, 2002

For: INTER-V4 REALM ROUTING

Atty. Docket No.: CISC737

Examiner: Unassigned

Group: 2661

Date: October 25, 2002

#2

RECEIVED  
OCT 31 2002  
Technology Center 2600

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on OCTOBER 25, 2002.

Signed: \_\_\_\_\_

Karen A. Hallock

INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR §§1.56 AND 1.97(c)

Assistant Commissioner for Patents  
Washington, DC 20231


Dear Sir:

The references listed in the attached PTO Form 1449, copies of which are attached, may be material to examination of the above-identified patent application. Applicants submit these references in compliance with their duty of disclosure pursuant to 37 CFR §§1.56 and 1.97. The Examiner is requested to make these references of official record in this application.

This Information Disclosure Statement is not to be construed as a representation that a search has been made, that additional information material to the examination of this application does not exist, or that these references indeed constitute prior art.

This Information Disclosure Statement is believed to be filed before the mailing date of a first Office Action on the merits. Accordingly, it is believed that no fees are due in connection with the filing of this Information Disclosure Statement. However, if it is determined that any fees are due, the Commissioner is hereby authorized to charge such fees to Deposit Account 50-1652 (Order No. CISC737).

Respectfully submitted,

  
Dan H. Lang  
Reg. No. 38,531

RITTER, LANG & KAPLAN LLP  
12930 Saratoga Ave., Suite D1  
Saratoga, CA 95070  
(408) 446-8690



Form 1449 (Modified)	Atty Docket No. CISCP737
<b>Information Disclosure Statement By Applicant</b> (Use Several Sheets if Necessary)	Application No.: 10/061,553
	Inventor JOHN ALBERT TOEBES, et al.
	Group 2661
	Filing Date February 1, 2002

#### U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub- Class	Filing Date

RECEIVED

#### Other Documents

OCT 31 2002

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication	Technology Center 2600
	A	<b>Postel</b> , "Internet Protocol," Request for Comments 791, Internet Engineering Task Force, September 1981.	
	B	<b>Rekhter, et al.</b> , "A Border Gateway Protocol 4 (BGP-4)," Request for Comments 1771, Internet Engineering Task Force, March 1995.	
	C	<b>R. Gilligan, et al.</b> "Transition Mechanisms for IPv6 Hosts and Routers," Request for Comments 1933, Internet Engineering Task Force, April 1996.	
	D	<b>R. Callon, et al.</b> "Routing Aspects of IPv6 Transition," Request for Comments 2185, Internet Engineering Task Force, September 1997.	
	E	<b>A. Conta, et al.</b> "Generic Packet Tunneling in IPv6 Specification," Request for Comments 2473, Internet Engineering Task Force, December 1998.	
	F	<b>B. Carpenter, et al.</b> "Transmission of IPv6 over IPv4 Domains Without Explicit Tunnels," Request for Comments 2529, Internet Engineering Task Force, March 1999.	
	G	<b>P. Srisuresh, et al.</b> "IP Network Address Translator (NAT) Terminology and Considerations," Request for Comments 2663, Internet Engineering Task Force, August 1999.	
	H	<b>Tsirtsis, et al.</b> , "Network Address Translation - Protocol Translation (NAT-PT)," Request for Comments 2766, Internet Engineering Task Force, February 2000.	
	I	<b>Tsuchiya, et al.</b> , "Dual Stack Hosts Using the "Bump in the Stack Technique," Request for Comments 2767, Internet Engineering Task Force, February 2000.	
	J	M. A. Miller, "Implementing IPv6, Second Edition: Supporting the Next Generation Protocols, Ch. 9, pp. 285-310, 2000.	
Examiner		Date Considered	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.